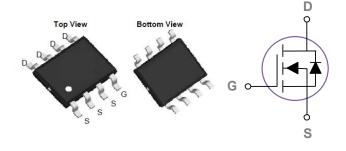


40V N-Channel MOSFET

General Description

The KSP4480 series are from Advanced Power innovated design and silicon process technology to achieve the lowest possible onresistance and fast switching performance. It provides the designer with an extreme efficient device for use in a wide range of power applications.

SOP-8 Pin Configuration



Product Summary

V _{DS} (V)	$\mathbf{R}_{DS(on)}$ (m Ω)	I _D (A)
40	9.8 at VGS = 10 V	12.4
	14.5 at V _{GS} = 4.5 V	9.5

Features

- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high EAS
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

Applications

- Load switching
- Hard switched and high frequency circuits
- Uninterruptible power supply

Absolute Maximum Ratings Tc=25°C unless otherwise noted

Symbol	Parameter	Rating	Units
Vds	Drain-Source Voltage	40	V
Vgs	Gate-Source Voltage	±20	V
	Drain Current – Continuous (Tc=25℃)	12.4	А
D	Drain Current – Continuous (Tc=100°C)	8.1	А
DM	Drain Current – Pulsed ¹	44	А
	Power Dissipation (Tc=25°C)	3	W
Po	Power Dissipation (Tc=100℃)	0.16	W/°C
Г _{STG}	Storage Temperature Range	-55 to 150	°C
Гј	Operating Junction Temperature Range	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit
R _{0JA}	Thermal Resistance Junction to ambient		53	°C/W
Rejc	Thermal Resistance Junction to Case		2.7	℃W

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Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	40			V
IDSS	Drain-Source Leakage Current	V _{DS} =35V , V _{GS} =0V , T _J =25℃			1	uA
		V _{DS} =35V , V _{GS} =0V , TJ=125℃			25	uA
lgss	Gate-Source Leakage Current	V_{GS} = $\pm 20V$, V_{DS} = $0V$			±100	nA

On Characteristics

R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V , I _D =10A		9.7	13	mΩ
		V _{GS} =4.5V , I _D =8A		14.4	19	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =250uA	1.0	1.5	3	V
gfs	Forward Transconductance	V _{DS} =5V , I _S =10A		25		S

Dynamic and switching Characteristics

Qg	Total Gate Charge		 33	
Qgs	Gate-Source Charge	V _{DS} =20V , V _{GS} =10V , I _D =10A	 5.1	 nC
Q _{gd}	Gate-Drain Charge		 11	
T _{d(on)}	Turn-On Delay Time		 7.3	
Tr	Rise Time	VDs=20V,RL=2Ω	 19.2	 ns
$T_{d(off)}$	Turn-Off Delay Time	Vgs=10V,Rg=3Ω	 36	 115
Tf	Fall Time		 18	
Ciss	Input Capacitance		 1960	
Coss	Output Capacitance	V _{DS} =20V , V _{GS} =0V , F=1MHz	 230	 pF
Crss	Reverse Transfer Capacitance		 205	

Drain-Source Diode Characteristics and Maximum Ratings

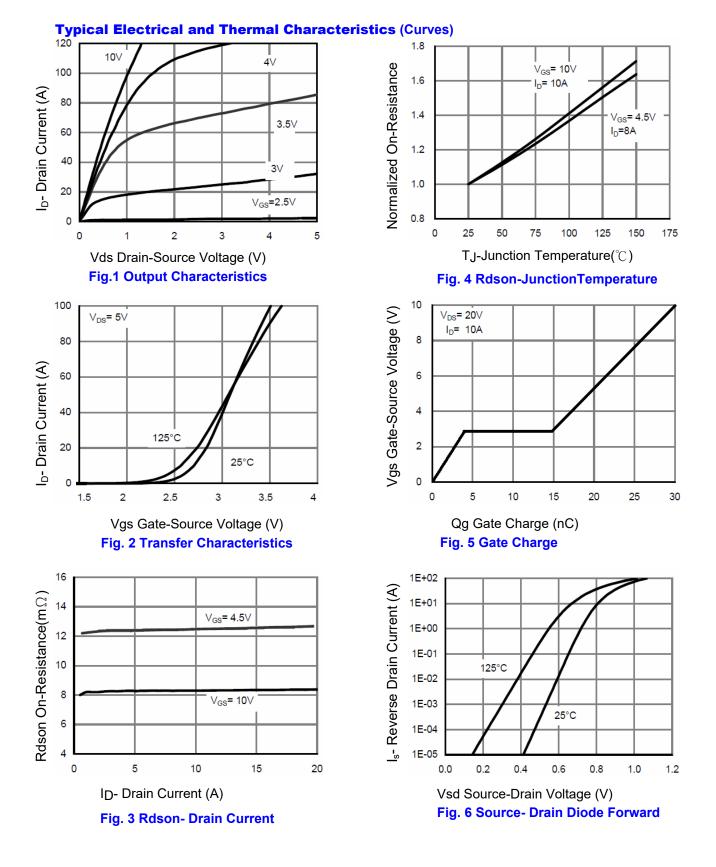
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
ls	Continuous Source Current	$V_G=V_D=0V$, Force Current			12.4	А
lsм	Pulsed Source Current				30	А
V _{SD}	Diode Forward Voltage	V _{GS} =0V , Is=1A , Tյ=25℃			1.2	V

Note :

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production



40V N-Channel MOSFET



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40V N-Channel MOSFET

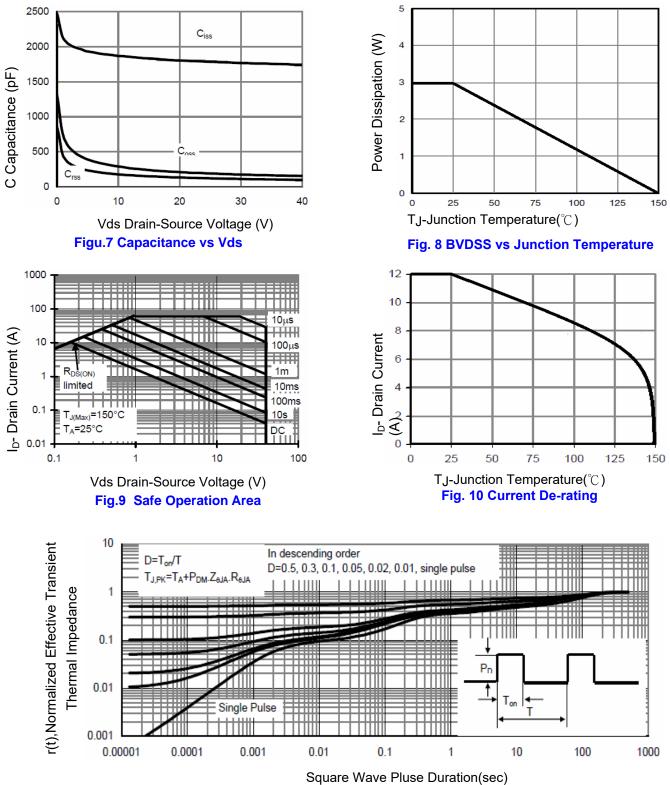


Fig.11 Normalized Maximum Transient Thermal Impedance



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